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July 2012

### FPF3003 IntelliMAX<sup>™</sup> Full Functional Input Power Path Management Switch for Dual-Battery Portable System

#### Features

SEMICONDUCTOR

- 2.3V to 5.5V Input Voltage Operating Range
- Low R<sub>ON</sub> between Battery and Load Maximum 50mΩ at V<sub>IN</sub> = 4.2V
- Low R<sub>ON</sub> between Charger and Battery Maximum 125mΩ at V<sub>IN</sub> = 4.2V
- Maximum DC Current for Load Switch: 2.5A
- Maximum DC Current for Charge Switch: 1.5A
- Slew Rate Controlled to 30µs Nominal Rise Time
- Seamless Break-Before-Make Transition
- Quiescent Current: 30µA Typical
- Thermal Shutdown
- Reverse Current Blocking (RCB) between Battery A and Battery B
- RESET Timer Delay: 7s Typical
- ESD Protected:
  - Human Body Model: >2.5kV
  - Charged Device Model: >1.5kV
  - IEC 61000-4-2 Air Discharge: >15kV
  - IEC 61000-4-2 Contact Discharge: >8kV
- 1.6mm X 1.6mm, 16-Bump, 0.4mm Pitch, WLCSP

#### Applications

- Dual-Battery Cell phone
- Dual-Battery Portable Equipment

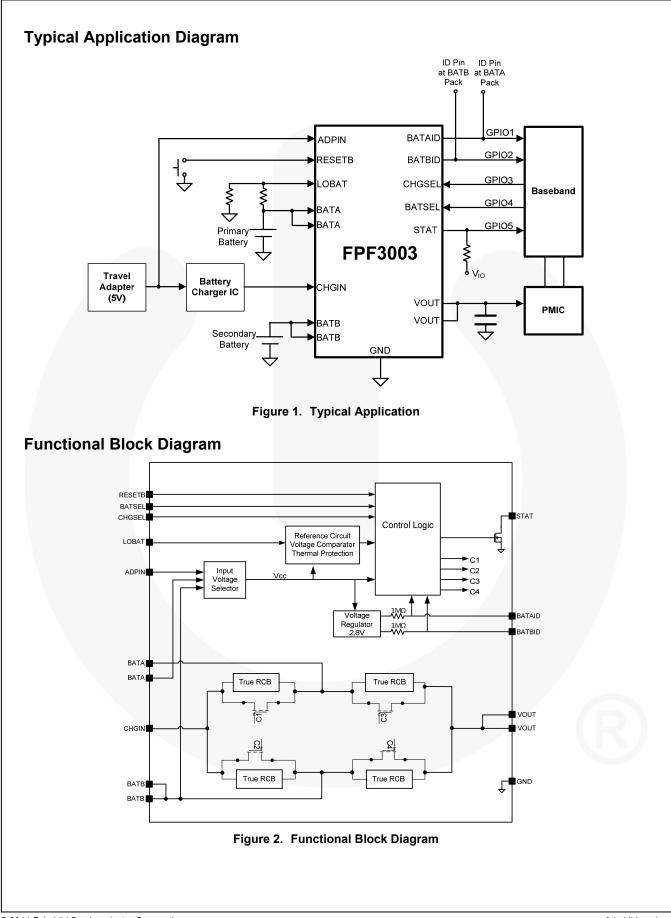
#### **Ordering Information** (Charger-Battery) Typical (Battery-Load) Part Number **Top Mark** Package Max. R<sub>ON</sub> at 4.2V<sub>IN</sub> Max. Ron at 4.2VIN t<sub>R</sub> 16-Bump, 0.4mm Pitch, FPF3003UCX ωw 125mO 50mO 30µs 1.6mm x 1.6mm WLCSP

#### Description

The FPF3003 is a single-chip solution for dual-battery power-path switching, including integrated P-channel switches and analog control features. The input voltage range operates from 2.3V to 5.5V. The device selects one of two batteries to provide power to the system, enabling one battery to be charged by the external battery charger.

The FPF3003 has battery voltage monitoring to determine if the battery is under voltage. Special driver and digital circuitry allows the device to switch quickly between battery A and battery B, which allows hot swapping of battery packs. Maximum current from battery to load per channel is limited to a constant 2.5A and internal thermal shutdown circuits protect the part during fault conditions.

The FPF3003 is available in a 1.6mm x 1.6mm, 16-bump, Wafer-Level Chip-Scale Package (WLCSP).



#### **Pin Configuration**

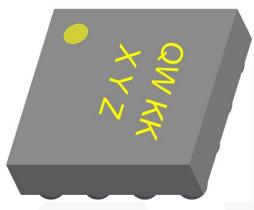


Figure 3. Pin Assignments (Top View)

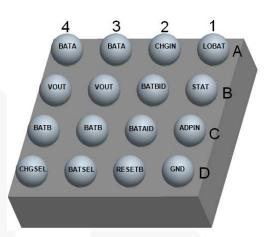


Figure 4. Pin Assignments (Bottom View)

#### **Pin Description**

Pin #	Name	Description			
A1	LOBAT	<b>Low Battery A Voltage Input</b> . Connect to the resistive divider to set the trip level for chip-on moment. If LOBAT is less than 0.8V, $V_{OUT}$ is connected to BATB.			
A2	CHGIN	Charging Input. Charging path input.			
A3, A4	BATA	Supply Input. Battery A voltage input.			
B1	STAT	<b>Battery Selector Status</b> . Open-drain output. HIGH (Hi-Z) means battery A connects to VOUT. LOW means battery B connects to VOUT.			
B2	BATBID	<b>Battery B Indicator</b> . Connect this pin with the ID pin at the battery pack of BATB. HIGH means battery B absent; LOW means battery B present.			
B3,B4	VOUT	Switch Output. Connect to system load.			
C1	ADPIN	Adapter Input. 5V input for battery charger.			
C2	BATAID	<b>Battery A Indicator</b> . Connect this pin with the ID pin at the battery pack of BATA. HIGH means battery A absent; LOW means battery A present.			
C3,C4	BATB	Supply Input. Battery B voltage input.			
D1	GND	Ground			
D2	RESETB	Reset Input. Active LOW. Both system path switches are disconnected from system load.			
D3	BATSEL	<b>Battery Selection Input</b> . HIGH means to switch battery B to VOUT; LOW means to switch battery A to VOUT.			
D4	CHGSEL	Charge Selection Input. HIGH means to charge battery B: LOW means to charge battery A.			

### **Absolute Maximum Ratings**

Stresses exceeding the Absolute Maximum Ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameters			Max.	Unit
V <sub>IN</sub>	All Pins To GND		-0.3	6.0	V
	Maximum Continuous Switch Current to Load			2.5	А
I <sub>SW</sub>	Maximum Continuous Switch Current to Charger			1.5	А
PD	Power Dissipation at T <sub>A</sub> = 25°C Operating and Storage Junction Temperature			1.7	W
T <sub>STG</sub>	Operating and Storage	Junction Temperature	-65	150	°C
Θ <sub>JA</sub>	Thermal Resistance, Junction to Ambient (1in. Square Pad of 2oz. Copper)			72 <sup>(1)</sup>	°C/W
		Human Body Model, JESD22-A114	2.5		
	D Electrostatic Discharge Capability	Charged Device Model, JESD22-C101	1.5		
ESD		Air Discharge (BATA, BATB, ADPIN to GND), IEC61000-4-2 System Level	15.0		kV
		Contact Discharge (BATA, BATB, ADPIN to GND), IEC61000-4-2 System Level	8.0		

Note:

1. Measured using 2S2P JEDEC std. PCB.

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameters	Min.	Max.	Unit
V <sub>IN</sub>	ADPIN	4.6	5.5	V
	BATA, BATB	2.3	5.5	V
T <sub>A</sub>	Ambient Operating Temperature	-40	85	°C

FPF3003 — IntelliMAX™ Full Functional Input Power Path Management Switch for Dual-Batterv Portable Systems

**Electrical Characteristics** 

ADPIN=4.6 to 5.5V,  $V_{BATA}=V_{BATB}=2.3$  to 5.5V,  $T_A=-40$  to 85°C unless otherwise noted. Typical values are at ADPIN=5V, CHGIN=V\_{BATA}=V\_{BATB}=4.2V, RESETB=HIGH, and  $T_A=25$ °C.

Symbol	Parameters	Condition	Min.	Тур.	Max.	Unit
Static Char	acteristics					
VADPIN	Adapter Input Voltage		4.6		5.5	V
V <sub>ADPIN_TH</sub>	ADPIN Threshold	ADPIN Rising		4.5		V
		ADPIN Falling		4.2		V
V <sub>bata</sub> , V <sub>batb</sub>	Battery Input Voltage		2.3		5.5	V
Ι <sub>Q</sub>	Quiescent Current	I <sub>OUT</sub> =0mA		30		μA
		$V_{BATA} = V_{BATB} = 5.5V, I_{OUT} = 300mA, T_A = 25^{\circ}C^{(2)}$		34		-
	On Resistance to Load Switch, BATA	$V_{BATA}=V_{BATB}=4.2V$ , $I_{OUT}=300mA$ , $T_{A}=25^{\circ}C$		38	50	
	or BATB to VOUT	V <sub>BATA</sub> =V <sub>BATB</sub> =3.7V, I <sub>OUT</sub> =300mA,T <sub>A</sub> =25°C		43	55	
		$V_{BATA}=V_{BATB}=2.3V$ , $I_{OUT}=300mA$ , $T_{A}=25^{\circ}C^{(2)}$		62		
		$V_{BATA} = V_{BATB} = 5.5V, I_{CHG} = 200mA, T_A = 25^{\circ}C^{(2)}$		66		- - mΩ -
_	On Resistance to	V <sub>BATA</sub> =V <sub>BATB</sub> =4.2V, I <sub>CHG</sub> =200mA, T <sub>A</sub> =25°C		73	90	
R <sub>ON</sub>	Charger Switch, CHGIN to BATA	$V_{BATA}=V_{BATB}=3.7V$ , $I_{CHG}=200mA$ , $T_{A}=25^{\circ}C$		80	95	
		V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V, I <sub>CHG</sub> =200mA, T <sub>A</sub> =25°C <sup>(2)</sup>		101		
	On Resistance to Charger Switch, CHGIN to BATB	$V_{BATA}=V_{BATB}=5.5V, I_{CHG}=200mA, T_{A}=25^{\circ}C^{(2)}$		92		
		V <sub>BATA</sub> =V <sub>BATB</sub> =4.2V, I <sub>CHG</sub> =200mA, T <sub>A</sub> =25°C		99	125	
		V <sub>BATA</sub> =V <sub>BATB</sub> =3.7V, I <sub>CHG</sub> =200mA, T <sub>A</sub> =25°C		105	130	
		V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V, I <sub>CHG</sub> =200mA, T <sub>A</sub> =25°C <sup>(2)</sup>		128		
	Input Logic HIGH	V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V – 5.5V, CHGSEL, BATSEL	0.90			v
V <sub>IH</sub>	Voltage	V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V – 5.5V, RESETB	1.15			
		V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V – 5.5V, BATAID, BATBID	1.70			
	Input Logic LOW Voltage	V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V – 5.5V, CHGSEL, BATSEL			0.6	v
VIL		V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V – 5.5V, RESETB			0.8	
		V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V – 5.5V, BATAID, BATBID			0.9	
V <sub>STAT_LO</sub>	STAT Logic LOW Voltage	I <sub>SINK</sub> =1mA			0.3	V
$V_{\text{LOBAT}}$	LOBAT Threshold	$V_{BATA}=V_{BATB}=2.3V-5.5V$		0.8		V
t <sub>lobat</sub>	LOBAT De-Glitch Time	V <sub>BATA</sub> =V <sub>BATB</sub> =2.3V – 5.5V		1.3		ms
		Shutdown Threshold		150		_
$T_{SD}$	Thermal Shutdown	Return from Shutdown		140		°C
		Hysteresis		10		
V <sub>DROOP_OUT</sub>	Output Voltage Droop while Battery Switching	$V_{BATA}$ =4.2V, $V_{BATB}$ =4.2V, Switching from $V_{BATA} \rightarrow V_{BATB}$ , $R_L$ =100 $\Omega$ , $C_{OUT}$ =10 $\mu$ F			100	mV

Continued on the following page...

#### **Electrical Characteristics**

ADPIN=4.6 to 5.5V,  $V_{BATA}=V_{BATB}=2.3$  to 5.5V,  $T_A=-40$  to 85°C unless otherwise noted. Typical values are at ADPIN=5V, CHGIN=V\_{BATA}=V\_{BATB}=4.2V, RESETB=HIGH, and  $T_A=25$ °C.

Symbol	Parameters	Condition	Min.	Тур.	Max.	Unit
Reverse Cu	urrent Blocking betwee	en V <sub>BATA</sub> and V <sub>BATB</sub>				
$V_{T\_RCB}$	RCB Protection Trip Point	V <sub>OUT</sub> – V <sub>BATA</sub> or V <sub>BATB</sub>		20		mV
$V_{R_{RCB}}$	RCB Protection Release Trip Point	V <sub>BATA</sub> or V <sub>BATB</sub> -V <sub>OUT</sub>		30		mV
	Hysteresis			50		mV
Dynamic C	haracteristics: See De	finitions Below				
t <sub>R</sub>	V <sub>OUT</sub> Rise Time <sup>(2,3,4)</sup>	$V_{BATA}=V_{BATB}=4.2V$ , $R_L=100\Omega$ , $T_A=25^{\circ}C$ , $C_L=10\mu$ F, BATAID=HIGH to LOW, BATBID=HIGH		30		μs
t <sub>DON</sub>	Turn-On Delay <sup>(2,3,4)</sup>			5		μs
t <sub>ON</sub>	Turn-On Time <sup>(2,3,4)</sup>			35		
tF	V <sub>OUT</sub> Fall Time <sup>(2,3,5)</sup>	$V_{BATA} = V_{BATB} = 4.2V, R_{I} = 100\Omega, T_{A} = 25^{\circ}C,$		2.5		ms
t <sub>DOFF</sub>	Turn-Off Delay <sup>(2,3,5)</sup>	C <sub>L</sub> =10µf, BATAID=LOW to HIGH,		0.1		ms
t <sub>OFF</sub>	Turn-Off Time <sup>(2,3,5)</sup>	BATBID=HIGH		2.6		ms
t <sub>DSEL</sub>	Selection Delay <sup>(2,3)</sup>	$V_{BATA}=V_{BATB}=4.2V$ , $R_L=100\Omega$ , $T_A=25^{\circ}C$ , $C_L=10\mu$ F, CHGSEL or BATSEL=LOW to HIGH		1		ms
t <sub>DRST</sub>	RESET Timer Delay <sup>(2,3)</sup>	$V_{BATA}=V_{BATB}=4.2V$ , $R_L=100\Omega$ , $T_A=25^{\circ}C$ , $C_L=10\mu$ F, RESETB=Floating to LOW		7		s

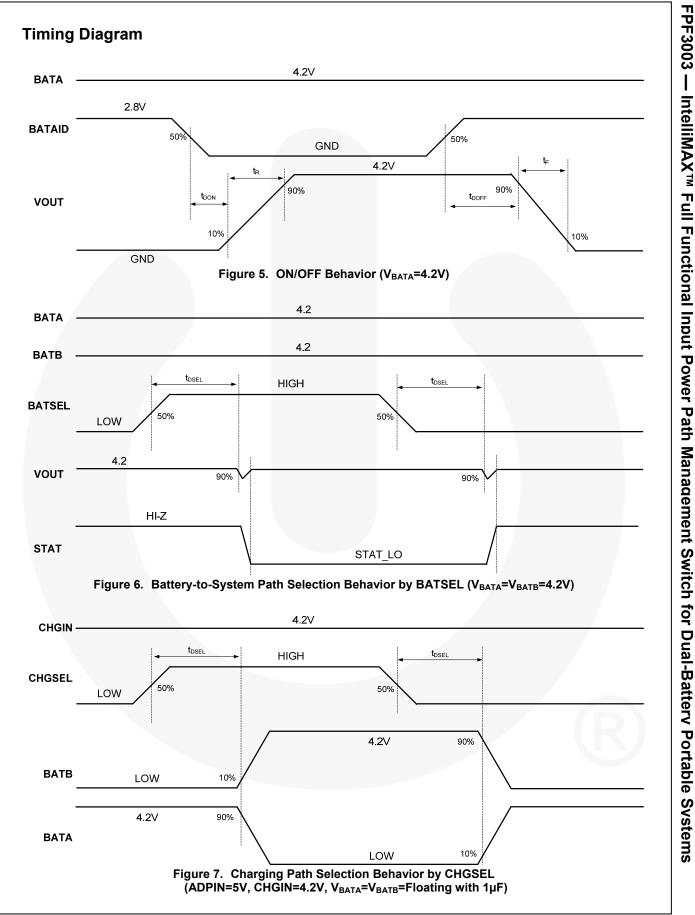
Notes:

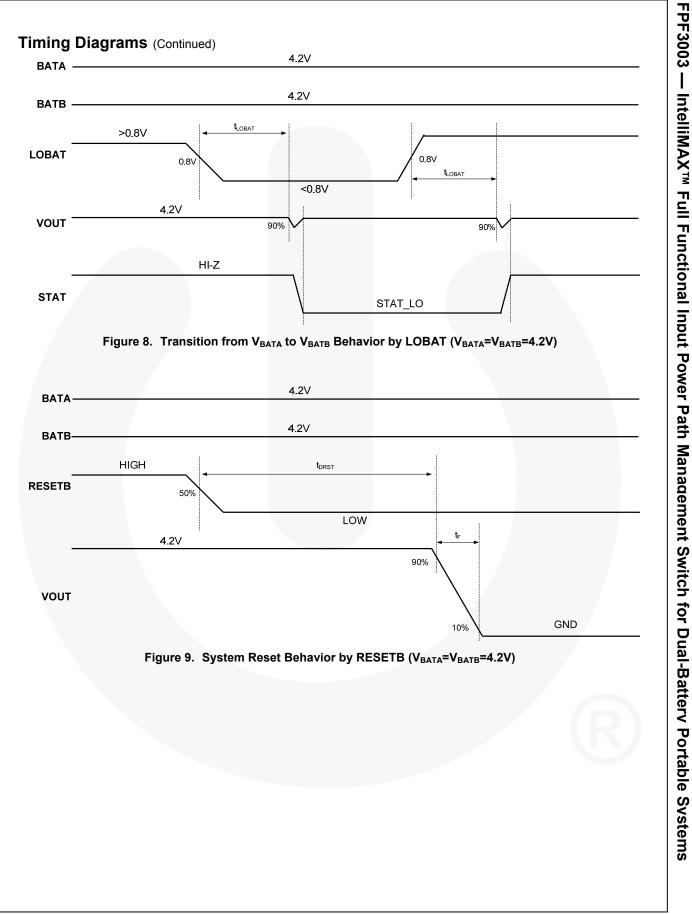
2. This parameter is guaranteed by design and characterization; not production tested.

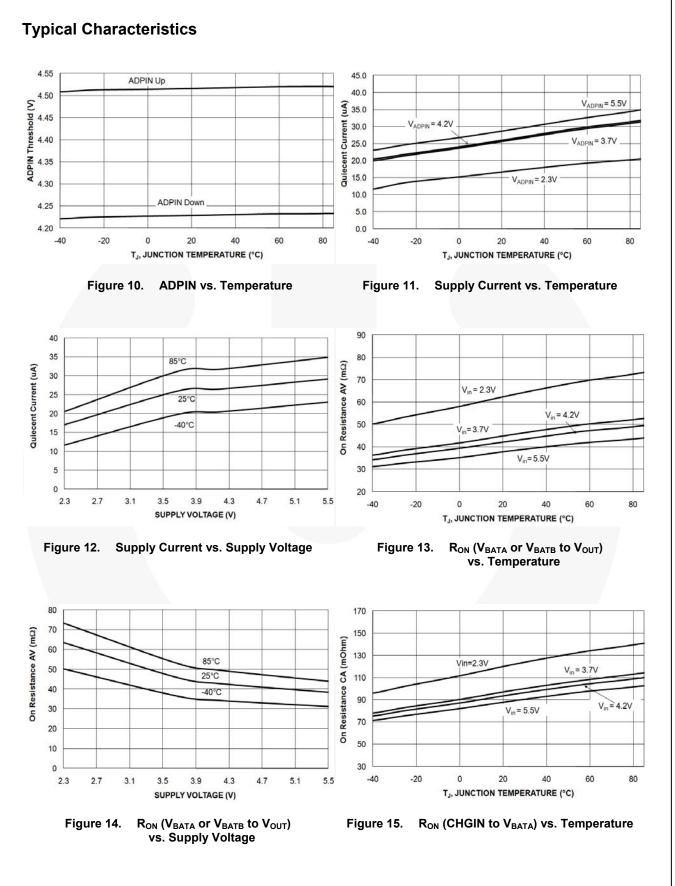
3.  $t_{DON}/t_{DOFF}/t_R/t_F$  is defined in Figure 5.

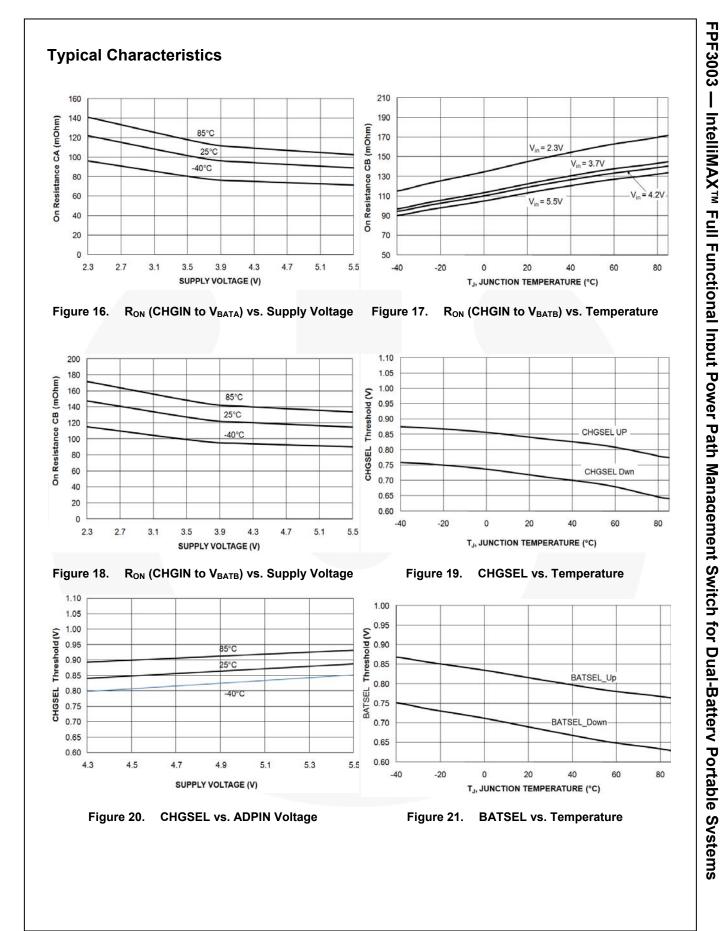
4.  $t_{ON}=t_R + t_{DON}$ .

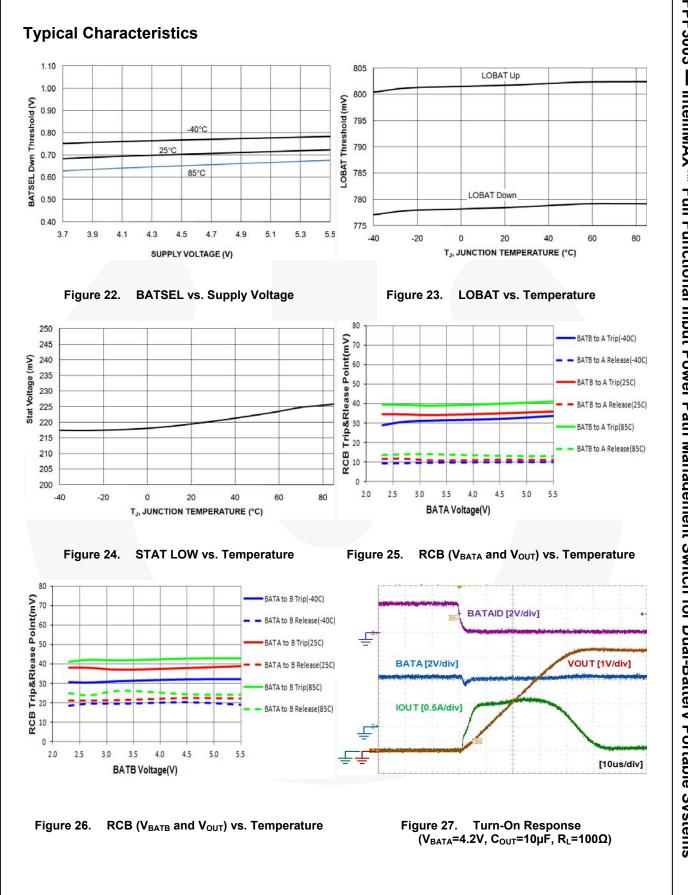
5.  $t_{OFF}=t_F + t_{DOFF}$ .



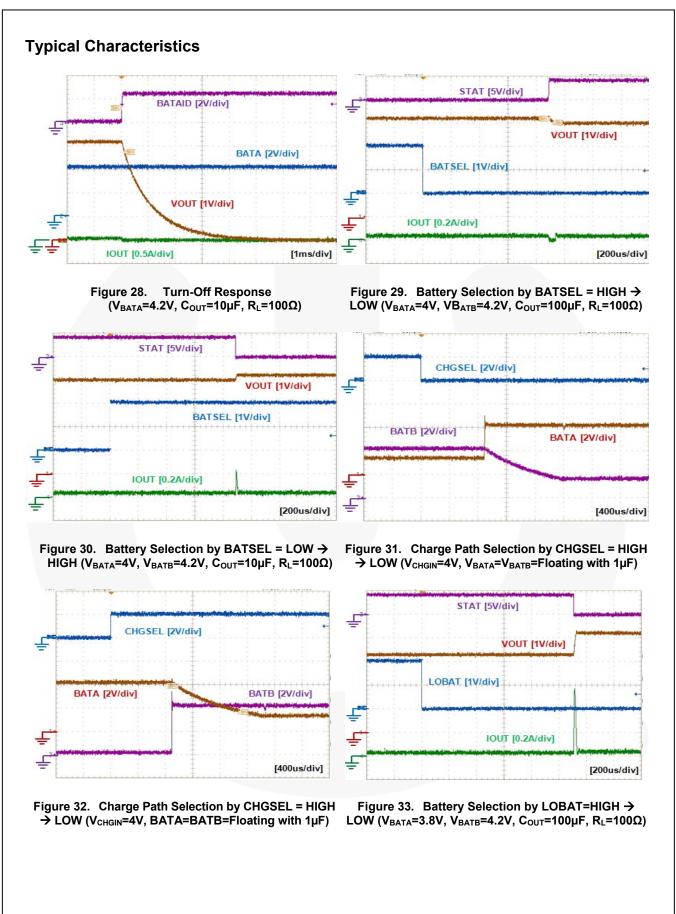


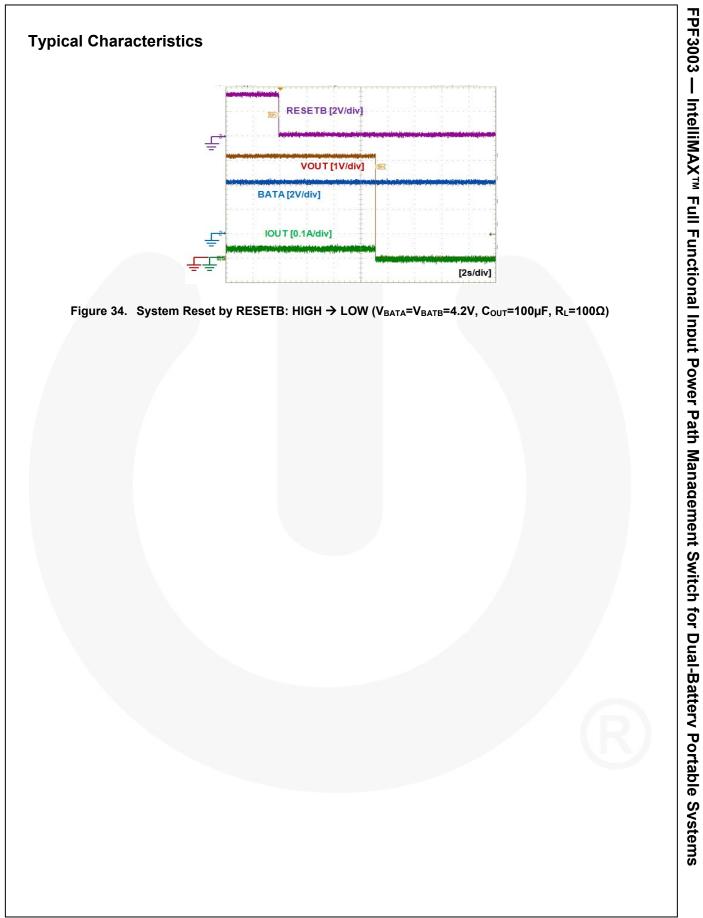






FPF3003 — IntelliMAX™ Full Functional Input Power Path Management Switch for Dual-Batterv Portable Systems





#### **Operation and Application Information**

The FPF3003 is a low- $R_{ON}$ , P-channel-based, inputsource-selection power management switch for dualbattery systems. The FPF3003 input operating range is from 2.3V to 5.5V on BATA and BATB, while ADPIN has a range of 4.6V to 5.5V.

The FPF3003 controls the charging path from the charger to the battery with up to 1.5A and the discharging path from the battery to system load with up to 2.5A. The system or PMIC selects one of two batteries to provide power and enables one of the batteries to be charged by the external battery charger.

The FPF3003 has 30µs slew-rate control to reduce inrush current when engaged and thermal shutdown protection for reliable system operation.

The internal circuit is powered from the highest voltage source among BATA, BATB, and ADPIN.

#### **Battery Presence Detection**

The FPF3003 monitors whether or not a battery is present via the BATAID and BATBID pins. If any of these pins are LOW; FPF3003 recognizes the battery is present. Each pin is connected with an internal LDO output, so no pull-up resistor is required.

#### **Output Capacitor**

During battery source transition, voltage droop depends on output capacitance and load current condition. Advanced break-before-make operation minimizes the droop with minimum capacitance. At least  $10\mu$ F is a good starting value in design.

#### **Primary Battery Under-Voltage Set**

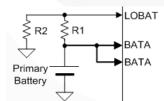
FPF3003 monitors the primary battery of BATA for under-voltage condition. Once under-voltage condition is confirmed, the system power source changes from BATA to valid BATB automatically.

The under-voltage threshold level can be programmed with 0.8V of LOBAT and R divider (R1 and R2) as:

$$\frac{R1}{R2} = \frac{BATA\_LO}{0.8} - 1$$
 (1)

where BATA\_LO = Low BATA threshold to set.

If 3.4V of BATA is desired, R1/R2=3.25. If R2 is chosen 1M $\Omega$ , R1 is 3.25M $\Omega$ . Higher R2 is recommended to reduce leakage current from BATA.



#### Figure 35. BATA Under-Voltage Level Setting

LOBAT has a 1.3ms of deglitch time to ensure BATA is in true under-voltage rather than transient battery voltage drop during GSM transmission operation.

#### **Battery Selection**

The load path can be controlled by the BATSEL pin. When BATSEL is LOW, the system is powered from BATA. When BATSEL is HIGH, BATB powers the system.

Figure 36 is state diagram showing how the power path from battery to system is determined.

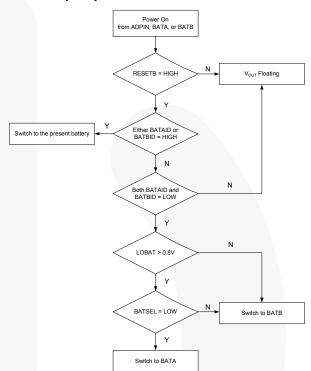
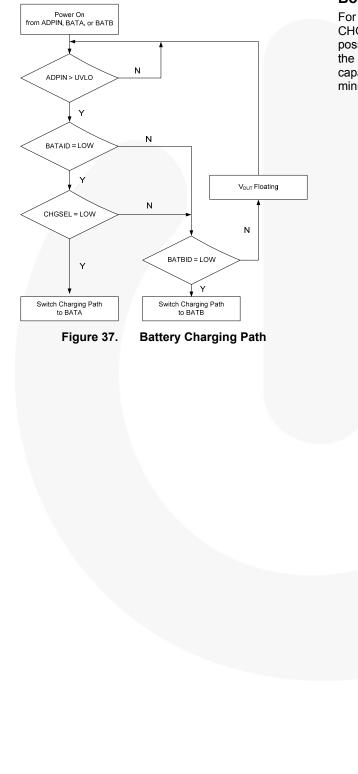


Figure 36. Power Path from Battery to System

The open-drain STAT pin is used to determine which battery powers the system. STAT becomes LOW if BATB is connected to the system. STAT is HIGH (HI-Z) if BATA is connected.

#### **Battery Charging Path Selection**

The charging path can be controlled by the CHGSEL pin. When CHGSEL is LOW, BATA can be charged from the charger. When CHGSEL is HIGH, BATB can be charged from the charger.

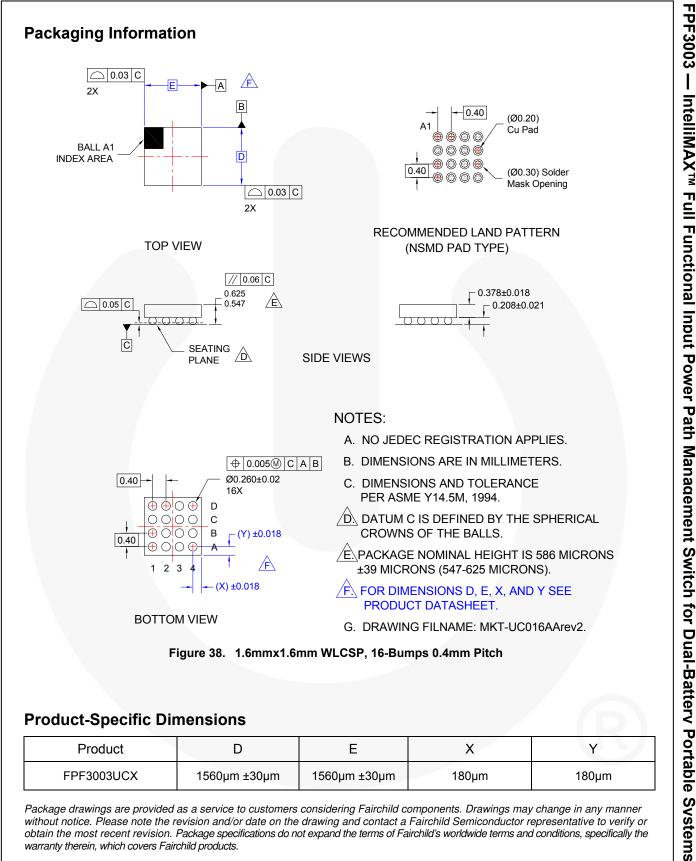


#### System RESET

The RESETB pin allows the system to be turned off without detaching the battery pack. It has typical 7s delay to avoid transient abnormal signal.

#### **Board Layout**

For best performance, all power traces (BATA, BATB, CHGIN, ADPIN, and VOUT) should be as short as possible to minimize the parasitic electrical effects and the case-to-ambient thermal impedance. The output capacitor should be placed close to the device to minimize parasitic trace inductance.



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